

QLS6B-FKW: PLCC6 3 in 1 SMD LED



PRODUCT DESCRIPTION

These SMD LEDs are packaged in an industry standard PLCC6 package. These high performance tricolor SMT LEDs are designed to work in a wide range of applications. A wide viewing angle and high brightness make these LEDs suitable for indoor signage applications.

FEATURES

- Size (mm): 4.7 x 1.5 x 1.3
- Dominant Wavelength Red (619 - 624nm)
 Green (520 - 540nm)
 Blue (460 - 480nm)
- Luminous Intensity (mcd) (900-2800)
- · Moisture Sensitivity Level: 3
- · Lead-Free
- · RoHS Compliant

APPLICATIONS

- Full-Color Video Screen
- Decorative Lighting
- Amusement



ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C)

lkama	Combal		Unit			
Items	Symbol	R	G	В	Onit	
Forward Current Note 1	l _F	30	20	20	mA	
Peak Forward Current Note 2	I _{FP}	200	100	100	mA	
Reverse Voltage	$V_{_{\mathrm{R}}}$	5	5	5	V	
Power Dissipation	P_{D}	78	76	76	mW	
Operation Temperature	T _{opr}		°C			
Storage Temperature	T _{stg}		-40 ~ +100			
Junction Temperature	$T_{_{J}}$	110	110	110	°C	
Junction/ambient 1 chip on	R _{THJA}	360	475	450	°C/W	
Junction/solder point 1 chip on	R _{THJS}	200	330	300	°C/W	
Junction/ambient 3 chip on	R _{THJA}	510	675	690	°C/W	
Junction/solder point 3 chip on	R _{THJS}	280	470	420	°C/W	

Note:

- 1. Single-color light
- 2. Pulse width ≤ 0.1 msec, duty $\leq 1/10$.

TYPICAL ELECTRICAL & OPTICAL CHARACTERISTICS (T_A = 25°C)

Characteristics	Condition	Symbol		Unit		
Cital acteristics	Condition	Syllibol	R	G	В	UIIIL
Dominant Wavelength	I _F = 14mA(R) I _F = 12mA(G) I _F = 16mA(B)	$\lambda_{ extsf{DOM}}$	619~624	520~540	460~480	nm
Spectral bandwidth at 50% I _{REL} max	I _F = 14mA(R) I _F = 12mA(G) I _F = 16mA(B)	Δλ	24	38	28	nm
Famous al Vallana	$I_F = 14\text{mA}(R)$		2.1	3.0	3.1	V
Forward Voltage	I _F = 12mA(G) I _F = 16mA(B)	V _{F(max)}	2.6	3.8	3.8	V
Luminous Intensity	I _F = 14mA(R) I _F = 12mA(G) I _F = 16mA(B)	I _{V(min)}		900-2800		mcd
Reverse Current (max)	V _R = 5 V	I _R	10	10	10	μΑ

Continuous reverse voltage can cause LED damage.



INTENSITY BIN LIMIT

RGB(14 mA /12 mA/16mA)						
Bin Code	Min.(mcd)	Max.(mcd)				
NS	900	2800				

^{*} Tolerance of measurement of luminous intensity is ±10%.

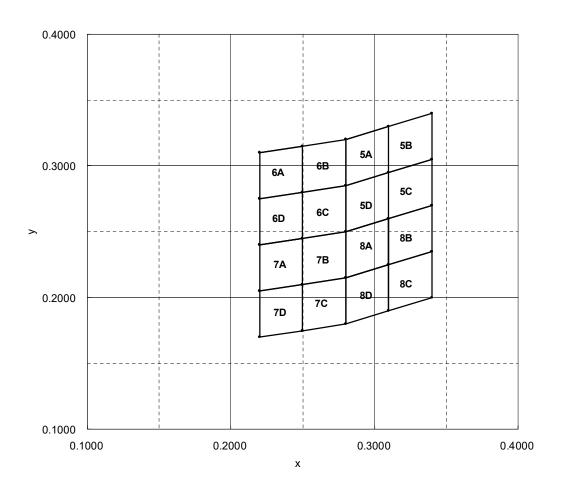
COLOR BIN LIMIT

Bin Cold	x	у	Region	x	у	Region	x	у	Region	x	у
	0.2800	0.3200		0.3100	0.3300	5C	0.3100	0.2950	5D	0.2800	0.2850
5A	0.3100	0.3300		0.3400	0.3400		0.3400	0.3050		0.3100	0.2950
5A	0.3100	0.2950	5B	0.3400	0.3050		0.3400	0.2700		0.3100	0.2600
	0.2800	0.2850		0.3100	0.2950		0.3100	0.2600		0.2800	0.2500
	0.2200	0.3100		0.2500	0.3150		0.2500	0.2800		0.2200	0.2750
6A	0.2500	0.3150	6 D	0.2800	0.3200	6C	0.2800	0.2850	6D	0.2500	0.2800
0A	0.2500	0.2800	6B	0.2800	0.2850		0.2800	0.2500		0.2500	0.2450
	0.2200	0.2750		0.2500	2500 0.2800		0.2500	0.2450		0.2200	0.2400
	0.2200	0.2400		0.2500	0.2450	7C	0.2500	0.2100	7D	0.2200	0.2050
7A	0.2500	0.2450		0.2800	0.2500		0.2800	0.2150		0.2500	0.2100
/A	0.2500	0.2100	7B	0.2800	0.2150		0.2800	0.1800		0.2500	0.1750
	0.2200	0.2050		0.2500	0.2100		0.2500	0.1750		0.2200	0.1700
	0.2800	0.2500		0.3100	0.2600	8C	0.3100	0.2250	8D	0.2800	0.2150
8A	0.3100	0.2600	0D	8B 0.3400 0.3400	0.2700		0.3400	0.2350		0.3100	0.2250
OA	0.3100	0.2250	OD		0.2350		0.3400	0.2000		0.3100	0.1900
	0.2800	0.2150		0.3100	0.2250		0.3100	0.1900		0.2800	0.1800

^{*} Tolerance of measurement of the color coordinates is ±0.02.



CIE CHROMATICITY DIAGRAM





ORDER CODE TABLE

		Luminous In	tensity (mcd)		
Kit Number	Color	Min.	Max.	Dominant Wavelength (nm)	Package
QLS6B-FKW-CNSNSF043	RGB	900	2800	5A,5B,5C,5D,6A,6B,6C,6D, 7A,7B,7C,7D,8A,8B,8C,8D,	Reel

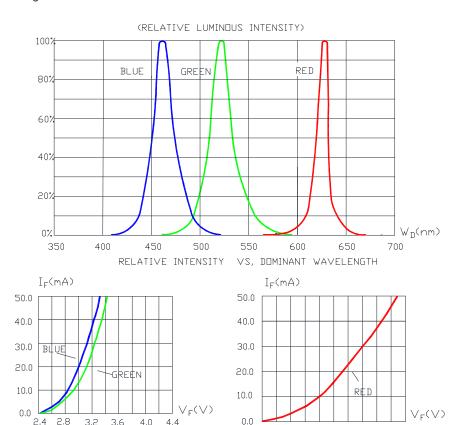
Notes:

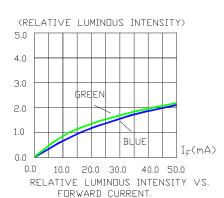
- The above kit numbers represent order codes that include multiple intensity-bin and color-bin codes. Only one intensity-bin code and one color-bin code will be shipped on each bulk. Single intensity-bin code and single color-bin codes will not be orderable.
- · Please refer to the HB LED Lamp Reliability Test Standards document for reliability test conditions.
- · Please refer to the HB LED Lamp Soldering & Handling document for information about how to use this LED product safely.



GRAPHS

The data below are collected from statistical figures that do not necessarily correspond to the actual parameters of each single LED. Hence, these data will be changed without further notice.



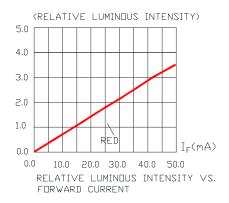


3.2 3.6

FORWARD CURRENT VS.

FORWARD VOLTAGE.

4.0 4.4



2.2

FORWARD CURRENT VS.

FORWARD VOLTAGE.

2.4

2.6

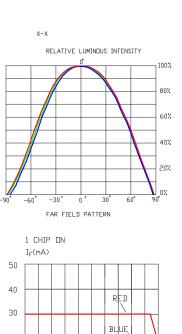
1.8 2.0

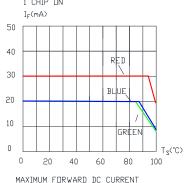
1.6



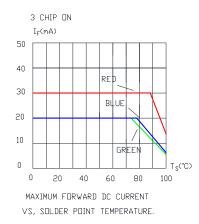
GRAPHS

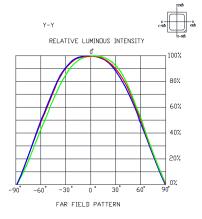
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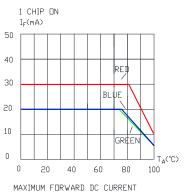


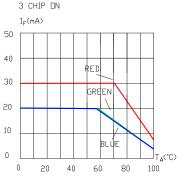


VS, SOLDER POINT TEMPERATURE.









VS, AMBIENT POINT TEMPERATURE.

MAXIMUM FORWARD DC CURRENT VS, AMBIENT POINT TEMPERATURE.



RELIABILITY

Туре	Test Item	REF.Standard	Test Condition	Note	Number of Damaged
8	Temperature Cycle	JEITA ED-4701 100 105	-40°C~25°C~100°C~25°C 30 mins, 5 mins, 30 mins, 5 mins	100 cycles	0/50
edneuc	Thermal Shock	MIL-STD-202G	-40°C~100°C 30 mins, 30 mins	100 cycles	0/50
nental s	High Temperature Storage	JEITA ED-4701 200 201	T _A =100°C	500 hrs	0/50
Environmental sequence	Humidity Heat Storage	JEITA ED-4701 100 103	T _a =60°C RĤ=90%	500 hrs	0/50
ம்	Low Temperature Storage	JEITA ED-4701 200 202	T _A =-40°C	500 hrs	0/50
nce	Life Test	-	$T_A=25^{\circ}\text{C}$ $I_F: R=G=B=W=150\text{mA}$	1000 hrs	0/30
n sequence	High Temperature Life Test	-	T _A =85°C I _F : R=G=B=W=80mA	1000 hrs	0/30
Operation	High Humidity Heat Life Test	-	T _A =60°C, RH=90% I _F : R=G=B=W=80mA	500 hrs	0/30
0	Low Temperature Life Test	-	$T_A=-40$ °C $I_F: R=G=B=W=150$ mA	500hrs	0/30

Judging Criteria

Thom	Symbol	Symbol Test Condition	Criteria for Judgment			
Item	Symbol	rest Condition	Min.	Max.		
Forward Voltage	$V_{\rm F}$	$I_F = 20 \text{ mA}$	-	Initial Data x 1.1		
Reverse Current	I_R	$V_R = 5 V$	-	10μΑ		
Luminous Flux/Intensity	Φ_{V}	$I_F = 20 \text{ mA}$	Initial Data x 0.7	-		



CAUTIONS

1. Cleaning

- When necessary, cleaning should occur only with isopropyl alcohol (IPA) at room temperature (25°C) for a duration of no more than one minute. Dry at room temperature for 15 minutes before use.
- The influence of ultrasonic cleaning on the SMD LED depends on factors such as ultrasonic power and the way the SMD LEDs are
 mounted. Ultrasonic cleaning should be pre-qualified to ensure this will not cause damage to the SMD LEDs.

2. Moisture-Proof Packing

- To prevent moisture absorption into SMD LEDs during the transportation and storage, the LEDs are packed in a moisture-barrier bag. Desiccants and a humidity indicator are packed together with the LEDs as secondary protection.
- · A humidity-indicator card inside the packing indicates the humidity level.

3. Storage

- The shelf life of LEDs stored in the original sealed bag at <40°C and <90%RH is 12 months. Baking is required if the shelf life has
 expired.
- · Before openning the packaging, check for air leaks in the bag.
- After the bag is opened, the SMD LEDs must be stored at < 30°C and < 60% RH. Under these conditions, SMD LEDs must be used (subject to reflow) within 168 hours. If the LEDs are not within 168 hours after removal from the bag, baking is required.
- To bake, place the SMD LEDs in an oven at 80°C ±5°C and relative humidity ≤10% RH for 24 hours.
- Take the material out of the packaging bag before baking. Do not open the oven door frequently during the baking process.

4. Soldering

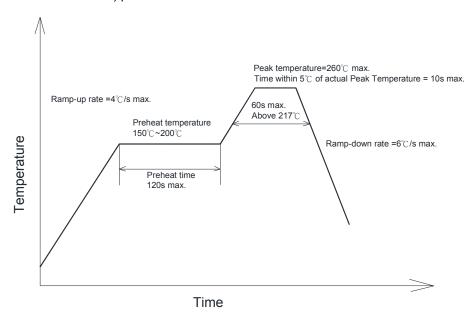
- a. Manual Soldering with a Soldering Iron
- Use of a soldering iron of less than 25 watts is recommended. The iron temperature must be kept below 315°C and soldering time no more than 2 seconds.
- The epoxy resin of an SMD LED should not contact the tip of the soldering iron.
- · No mechanical stress should be exerted on the resin portion of an SMD LED during soldering.
- Handling of an SMD LED should be done only when the package has been cooled down to below 40°C or less. This is to prevent SMD LED failures due to thermal-mechanical stress during handling.



CAUTIONS

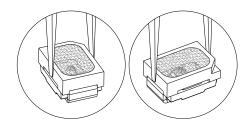
b. Reflow Soldering

Temperature (top surface of the SMD LED) profile:



NOTES

- SMD LEDs should not be modified after soldering. If modification cannot be avoided, the modifications must be pre-qualified to avoid damaging the SMD LEDs.
- · In case of 2 times reflow process, 2nd reflow process must be performed as soon as possible after the 1st reflow.
- No stress should be exerted on the package during soldering.
- The PCB should not be wrapped after soldering; allow the PCB board and SMD LED to cool naturally.
- The packaging sizes of these SMD products are very small and the resin is still soft after solidification. Users are required to handle with care. Never touch the resin surface of SMD products.
- To avoid damaging the product's surface and interior device, it is recommended to choose a special nozzle to pick up the SMD products during the process of SMT production. If handling is necessary, take special care when picking up these products. The following method is necessary:

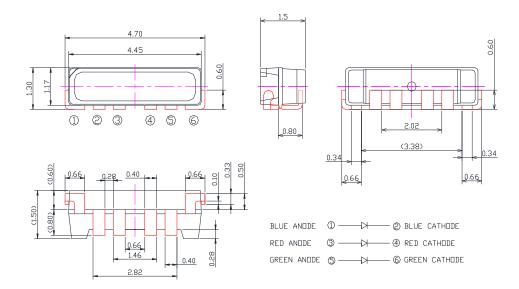




MECHANICAL DIMENSIONS

All dimensions are in mm.

Tolerance of measurement of the dimension is ± 0.1 .



NOTES

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree LED representative or from the Product Ecology section of the Cree LED website.

Vision Advisory

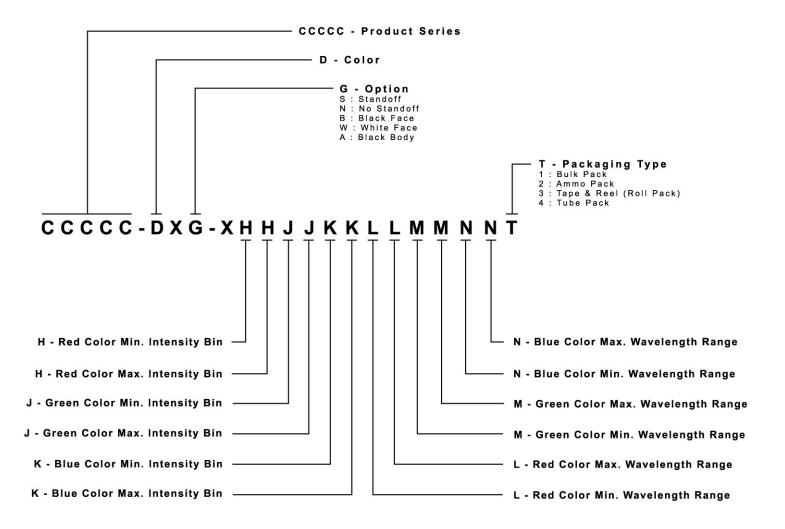
WARNING: Do not look at an exposed lamp in operation. Eye injury can result.



KIT NUMBER SYSTEM

Cree LED lamps are tested and sorted into performance bins. A bin is specified by ranges of color, forward voltage, and brightness.

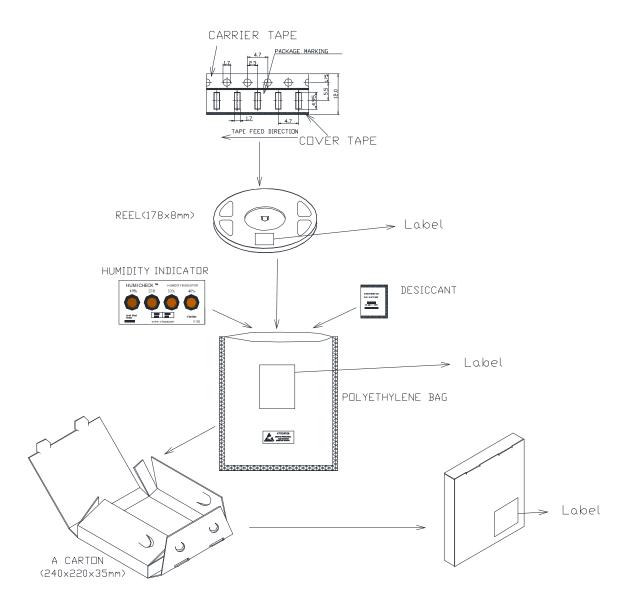
Cree LEDs are sold by order codes in combinations of bins called kits. Order codes are configured in the following manner:





PACKAGING

- The boxes are not water resistant and they must be kept away from water and moisture.
- The LEDs are packed in cardboard boxes after packaging in normal or anti-electrostatic bags.
- · Cardboard boxes will be used to protect the LEDs from mechanical shocks during transportation.
- · The reel pack is applied in SMD LED.
- Max 3000 pcs per reel.



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Cree LED:

QLS6B-FKW-CNSNSF043